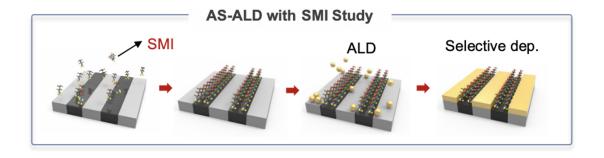
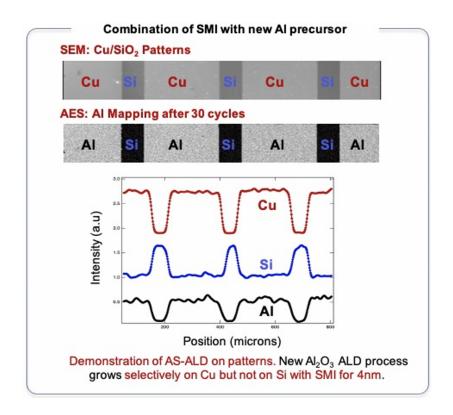
Docket #: S20-290

Selective Atomic Layer Deposition of Al2O3 with a New Precursor and Small Molecule Inhibitor

Researchers from the Bent group have identified a new precursor and small molecule inhibitor combination for Al₂O₃ area-selective atomic layer deposition (ALD). Important for back end of line (BEOL) processes of high-volume manufactured semiconductor devices, Al_2O_3 ALD is crucially used as a hard mask and thus requires clean edges with high area selectivity. Also, Al_2O_3 has been widely used as semiconductor device components in front EOL (FEOL) such as gate oxide, passivation layers, and barrier layers, which also requires area-selective growth. Other applications using Al_2O_3 such as energy storage, sensing, and display may also benefit from area selective deposition. Current methods utilize trimethylaluminum (TMA) as an ALD precursor, but TMA exhibits low selectivity at commercially relevant thicknesses. Such an issue is further exacerbated as semiconductor features increasingly downsize. In contrast, the deposition process using the new aluminum precursor and small molecule inhibitor achieves 98% area selectivity up to 4 nm of Al₂O₃ on Cu and Si-OH substrates. This dramatic increase in selectivity, ~0% for TMA vs. 98% for the new precursor, demonstrates the high value of this system to various Al₂O₃ ALD applications.





Stage of Research

Proof of concept

Applications

- ALD requiring control over location, thickness, and roughness without external liquid-phase processing steps
- ALD for topography or patterning at back end of line
- ALD for gate oxide, passivation layer, and barrier layer at front end of line
- Selective ALD deposition for nanoscale patterns

Advantages

- 98% selectivity up to 4nm using TEA vs. \sim 0% using TMA
- Applicable for bare Cu or Si-OH substrates, as well for a variety of other metals and metal oxides
- Vapor phase deposition of small molecule inhibitors for area-selective ALD

Publications

• Manuscript in preparation

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